Features

- Halogen Free. "Green" Device (Note 1)
- High Current Capability
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

1 Amp Surface Mount Schottky Rectifier 20 to 200 Volts

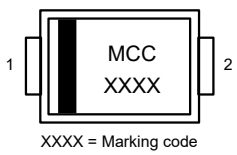
Maximum Ratings @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Value									Unit
		SK 12-L	SK 13-L	SK 14-L	SK 15-L	SK 16-L	SK 18-L	SK 110-L	SK 1150-L	SK 1200-L	
Peak Repetitive Reverse Voltage	V_{RRM}	20	30	40	50	60	80	100	150	200	V
Working Peak Reverse Voltage	V_{RWM}										
DC Blocking Voltage	V_R										
RMS Reverse Voltage	V_{RMS}	14	21	28	35	42	56	70	105	140	V
Average Rectified Forward Current	$I_{F(AV)}$	1									A
Non-Repetitive Peak Surge Current @ 8.3ms Half Sine Wave	I_{FSM}	30									A
Current Squared Time @1ms≤t≤8.3ms	I^2t	3.735									A^2s

Marking code

Part Number	Marking Code
SK12-L	SK12
SK13-L	SK13
SK14-L	SK14
SK15-L	SK15
SK16-L	SK16
SK18-L	SK18
SK110-L	SK110
SK1150-L	SK1150
SK1200-L	SK1200

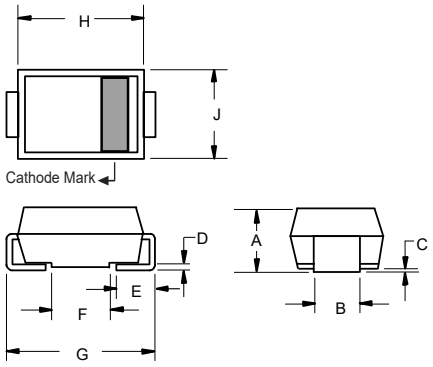
Internal Structure

Pin	Description	Simplified Outline	Graphic Symbol
1	Cathode	 XXXX = Marking code	
2	Anode		

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

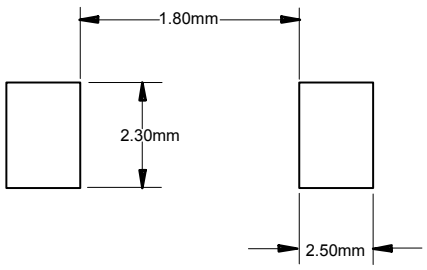
2. High temperature solder exemption applied, see EU directive annex 7a.

SMB(DO-214AA)



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.079	0.103	2.00	2.62	
B	0.075	0.087	1.91	2.21	
C	0.002	0.008	0.05	0.20	
D	0.006	0.012	0.15	0.31	
E	0.030	0.060	0.76	1.52	
F	0.065	0.091	1.65	2.32	
G	0.200	0.220	5.08	5.59	
H	0.160	0.191	4.06	4.85	
J	0.130	0.155	3.30	3.94	

Suggested Solder Pad Layout



Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_J	Operating Junction Temperature Range	SK12-L ~ SK14-L	-55		125	°C
T_J	Operating Junction Temperature Range	SK15-L ~ SK1200-L	-55		150	°C
T_{stg}	Storage Temperature Range		-55		150	°C
$Rth_{(J-L)}$	Thermal Resistance from Junction to Lead	Note 1		15		°C/W
$Rth_{(J-A)}$	Thermal Resistance from Junction to Ambient	Note 1		71		°C/W

Note:
1.Mounted on P.C.B. with 8mm*8mm copper pad areas.

Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Voltage						
SK12-L ~ SK14-L	V_F	I_F=1A;T_J=25°C			0.50	V
SK15-L ~ SK16-L					0.70	
SK18-L ~ SK110-L					0.85	
SK1150-L ~ SK1200-L					0.90	
Reverse Current						
SK12-L ~ SK16-L	I_R	at Rated V_R;T_J=25°C			0.1	mA
		at Rated V_R;T_J=125°C			20	
SK18-L ~ SK1200-L		at Rated V_R;T_J=25°C			0.01	
		at Rated V_R;T_J=125°C			5	
Junction Capacitance						
SK12-L ~ SK14-L	C_J	V_R=4V;f=1MHz;T_J=25°C		125		pF
SK15-L ~ SK16-L				90		
SK18-L ~ SK110-L				60		
SK1150-L ~ SK1200-L				50		

Curve Characteristics

Fig. 1 - Forward Current Derating Curve

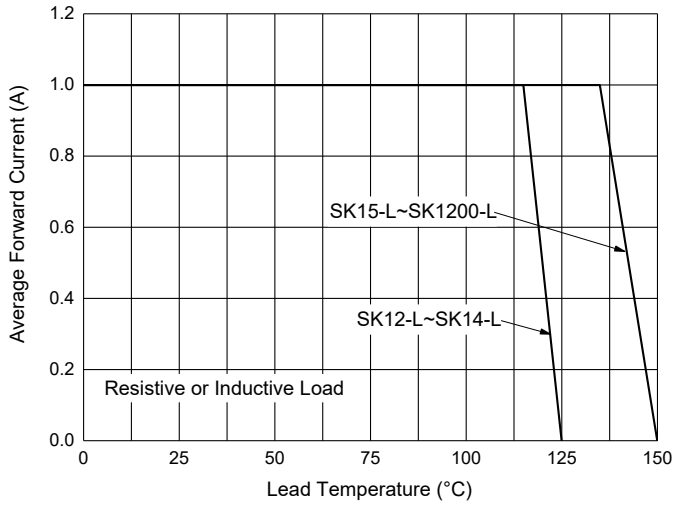


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

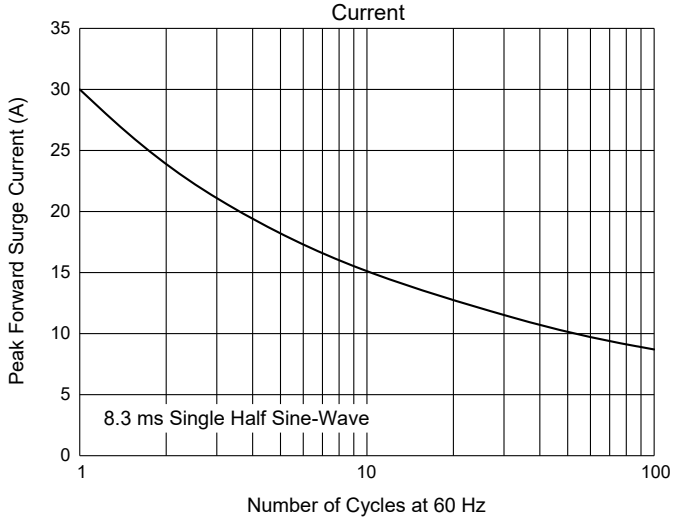


Fig. 3 - Typical Forward Characteristics

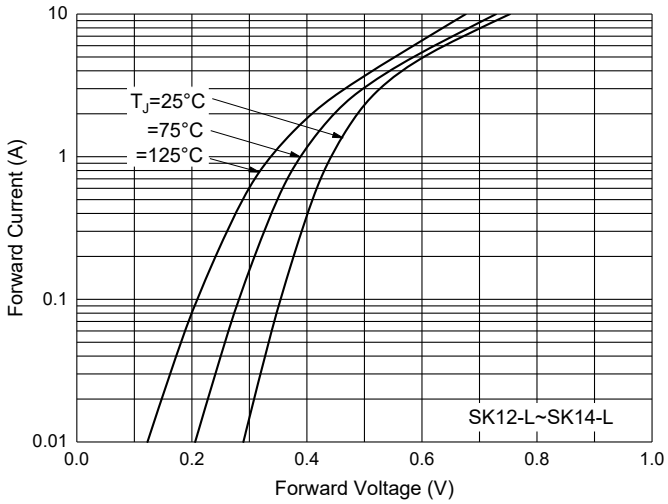


Fig. 4 - Typical Reverse Leakage Characteristics

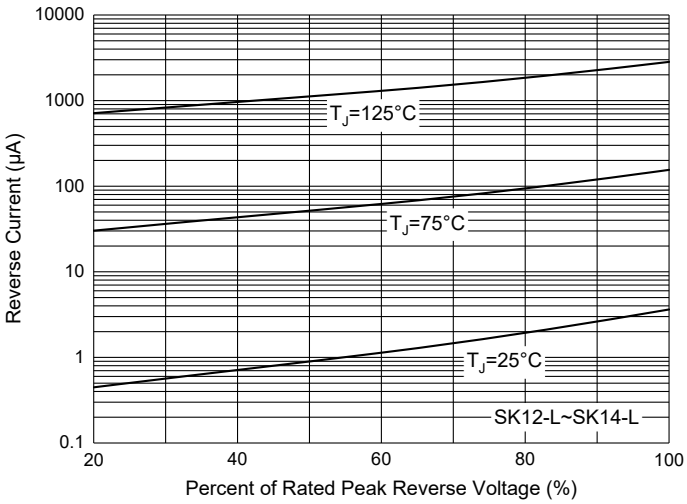


Fig. 5 - Typical Forward Characteristics

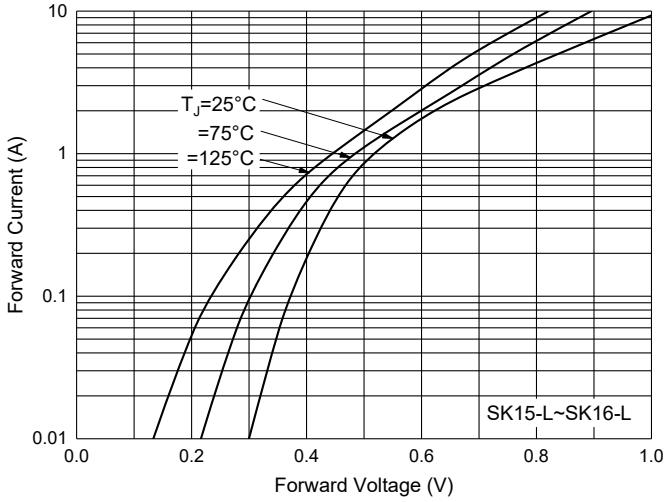
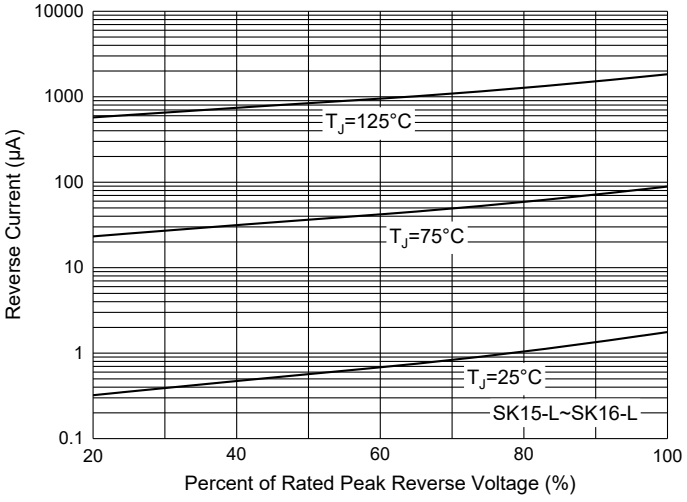


Fig. 6 - Typical Reverse Leakage Characteristics



Curve Characteristics

Fig. 7 - Typical Forward Characteristics

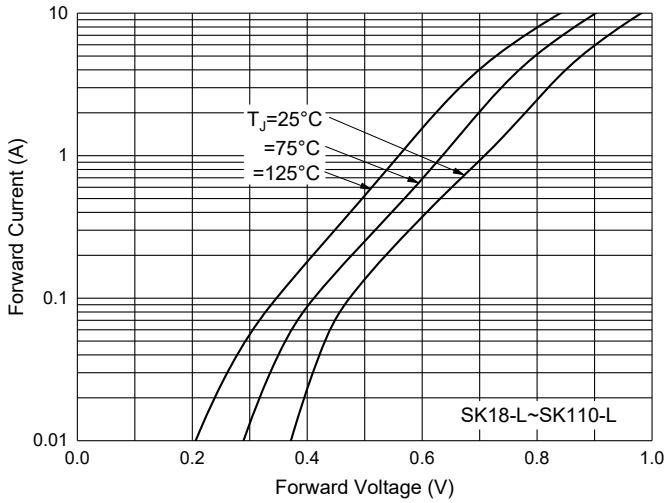


Fig. 8 - Typical Reverse Leakage Characteristics

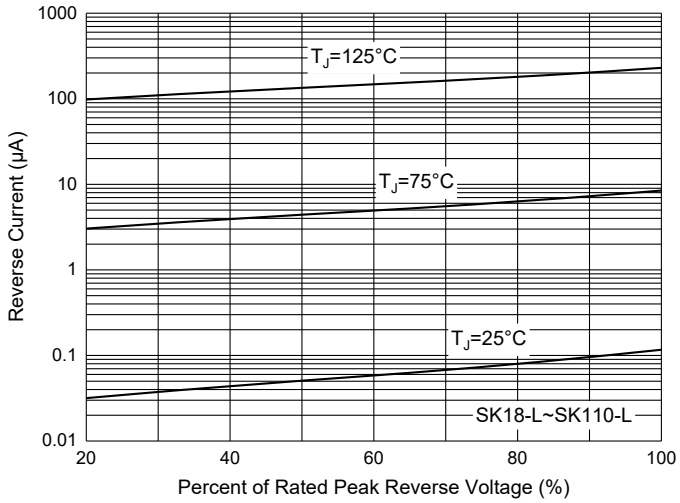


Fig. 9 - Typical Forward Characteristics

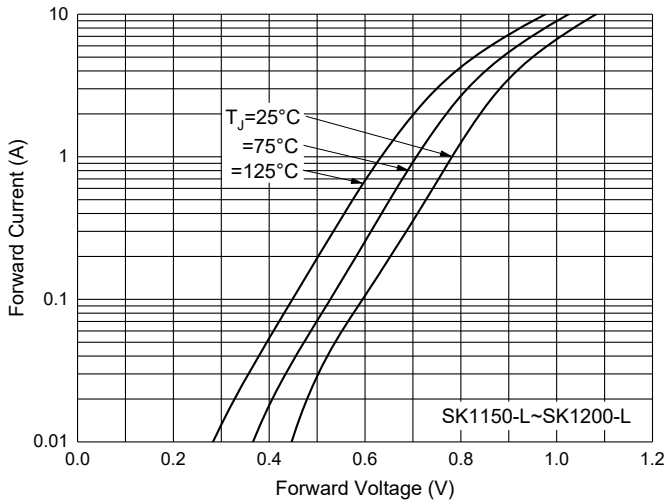


Fig. 10 - Typical Reverse Leakage Characteristics

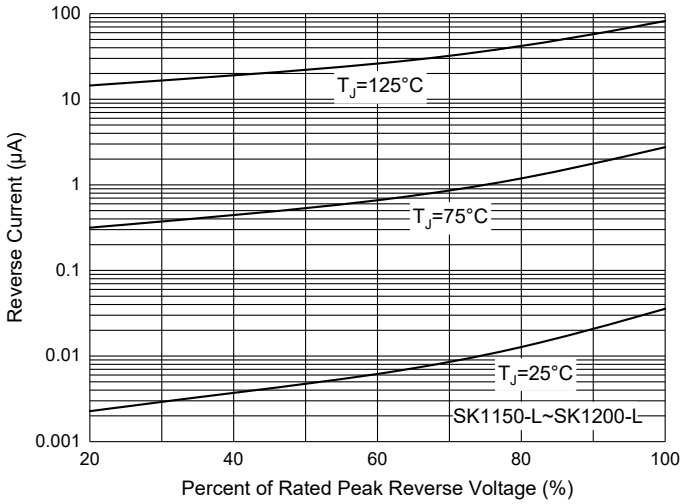
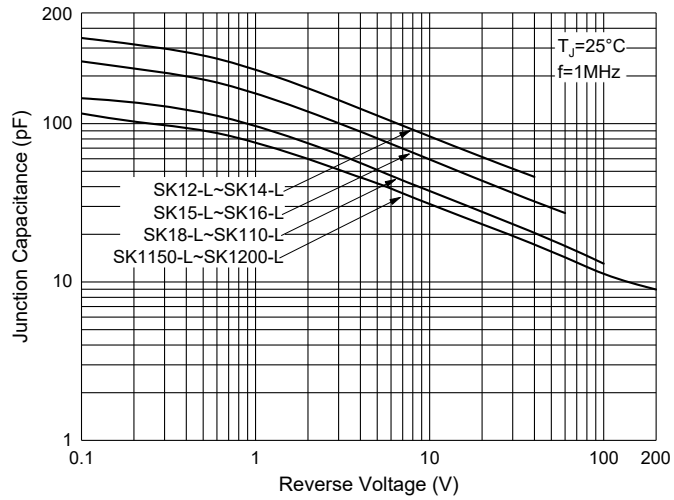


Fig. 11 - Typical Capacitance Characteristics



Ordering Information

Device	Packing
SK12-LTP ~ SK1200-LTP	Tape&Reel:3Kpcs/Reel